Display Elektronik GmbH

DATA SHEET

TFT MODULE

DEM 240320J TMH-PW-N

2,4“ TFT

Product Specification **Ver.: 3**

04.01.2014

Revision History

Revision	Date	Detail	Remarks
0	24.10.2013	Initial Release	-
1	05.11.2013	Modify Interface Modify Block Diagram and Power Supply Modify Interface Pins Definition Modify AC Characteristics Modify Outline Drawing	P4 P9 P10-P11 P13-P16 P30
2	11.11.2013	Modify Module Parameter Modify Block Diagram and Power Supply Modify Interface Pins Definition Modify AC Characteristics Modify Outline Drawing	P4 P9 P10,P11 P13,P14 P30
3	04.01.2014	Add Weight Add Current Modify Chromacity Transmissive Modify Outline Drawing	P5 P5 P6 P30

Table of Contents

1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size (Diagonal)	2.4”	-
LCD type	TN TFT	-
Display Mode	Transmissive /Normally white	-
Resolution	240 RGB x320	Pixels
View Direction	6 O’clock	Best Image
Gray Scale Inversion Direction	12 O’clock	-
Module Outline	42.72 x 60.26 x 2.65 (Note1)	mm
Active Area	36.72 x 48.96	mm
Pixel Size	0.153 x 0.153	mm
Pixel Arrangement	Stripe	-
Display Colors	262k	-
Interface	8080 MCU 8/16-Bit-Parallel Interface and 3/4-Wire Data Serial Interface	-
With or without Touch Panel	without	-
Driver IC	ILI9341V	-
Operating Temperature	-20～70	ºC
Storage Temperature	-30～80	ºC
Weight	9	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum Ratings

V_{SS}=0V, Ta=25ºC

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VCC	-0.3	4.6	V
	VCI	-0.3	4.6	V
Storage Temperature	T_{STG}	-30	+80	ºC
Operating Temperature	T_{OP}	-20	+70	ºC

Note 1: If Ta below 50ºC, the maximal humidity is 90%RH, if Ta over 50ºC, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10℃, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item		Symbol	Min.	Typ.	Max.	Unit
Supply Voltage		VCC	2.5	2.8	3.3	V
		VCI	1.65	2.8	3.3	V
Logic Low Input Voltage		V_{IL}	GND	-	0.3*VCI	V
Logic High Input Voltage		V_{IH}	0.7*VCI	-	VCI	V
Logic Low Output Voltage		V_{OL}	GND	-	0.2*VCI	V
Logic High Output Voltage		V_{OH}	0.8*VCI	-	VCI	V
Current Consumption All Black	Logic	I_{CC+} I_{IN}	-	10	20	mA
	Analog					

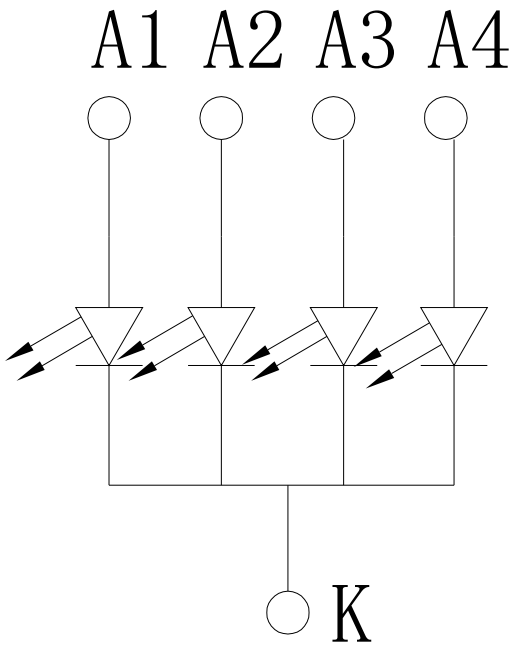
5. Backlight Characteristic

5.1. Backlight Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	V_F	Ta=25 ºC, I_F=15mA/LED	2.9	3.2	3.3	V
Forward Current	I_F	Ta=25 ºC, V_F=3.2V/LED	-	60	-	mA
Power Dissipation	P_D		-	192	-	mW
LED Life Time(25 ºC)	-	-	(50,000)	-	-	hr
Uniformity	Avg		-	80	-	%
Drive Method	Constant current					
LED Configuration	4 White LEDs in parallel					

Note: LED life time defined as follows: The final brightness is at 50% of original brightness.
The environmental conducted under ambient air flow, at Ta=25±2 ºC, 60%RH±5%.

5.2. Backlighting Circuit



6. Optical Characteristics

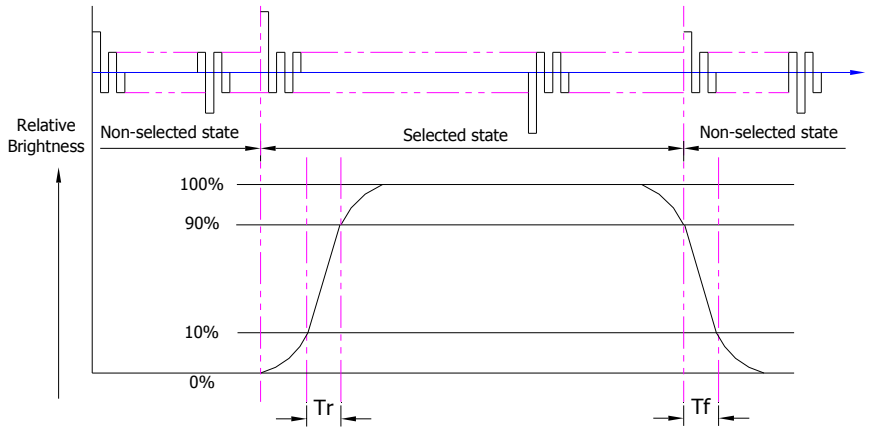
6.1. Optical Characteristics

Ta=25ºC, VCC=2.8V, TN LC+ Polarizer

	Item		Symbol	Condition	Specification			Unit
					Min.	Typ.	Max.	
Backlight On (Transmissive Mode)	Luminance on TFT(I_f =15mA/LED)		Lv	Normally viewing angle θX = φY =0º	200	250	-	cd/m²
	Contrast ratio(See 6.3)		CR		400	500	-	
	Response Time (See 6.2)		TR+TF		-	20	30	ms
	Chromaticity Transmissive (See 6.5)	Red	XR		0.575	0.625	0.675	
			YR		0.274	0.324	0.374	
		Green	XG		0.268	0.318	0.368	
			YG		0.540	0.590	0.640	
		Blue	XB		0.093	0.143	0.193	
			YB		0.052	0.102	0.152	
		White	XW		0.258	0.308	0.358	
			YW		0.298	0.348	0.398	
	Viewing Angle (See 6.4)	Horizontal	θX+	Center CR≥10	60	70	-	Deg.
			θX-		60	70	-	
		Vertical	φY+		60	70	-	
			φY-		50	60	-	
	NTSC Ratio(Gamut)				-	60	-	%

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)

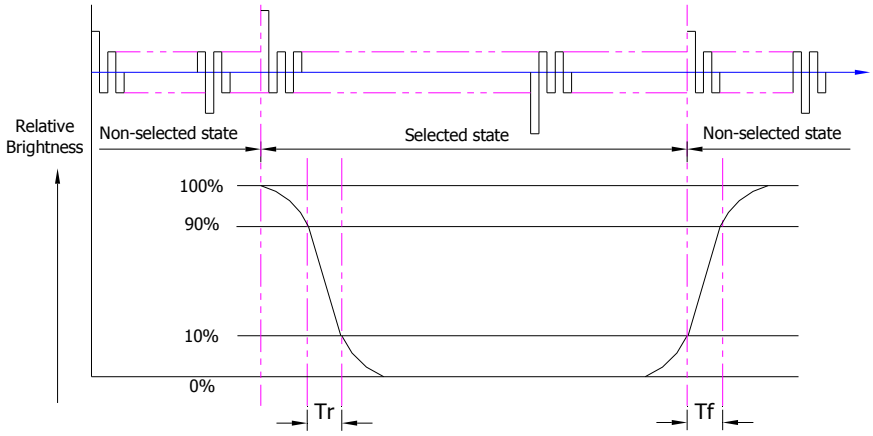


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note : Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note : Measuring machine: LCD-5100 or EQUI

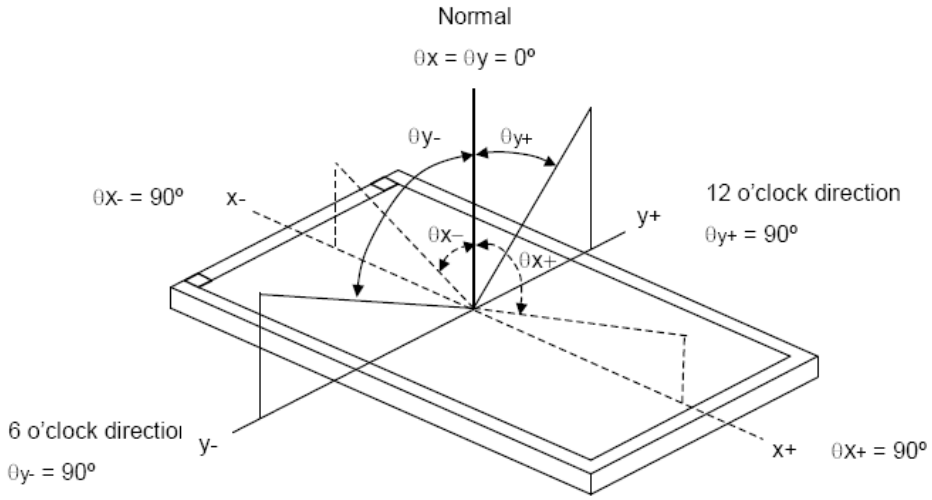
6.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles



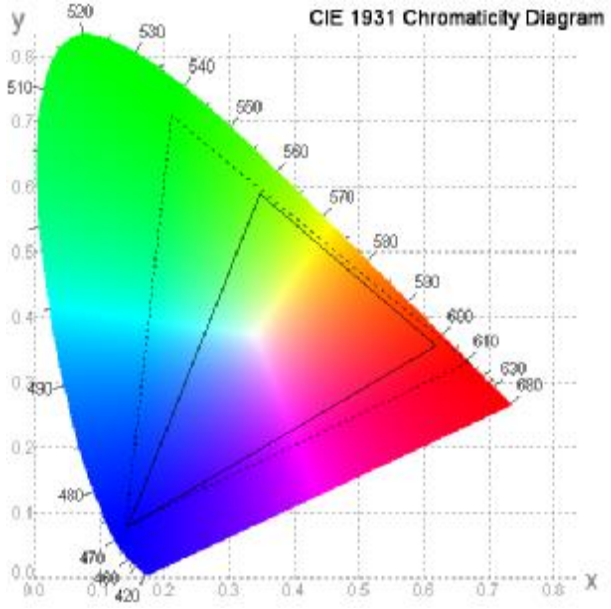
Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)



6.6. Definition of Surface Luminance, Uniformity and Transmittance

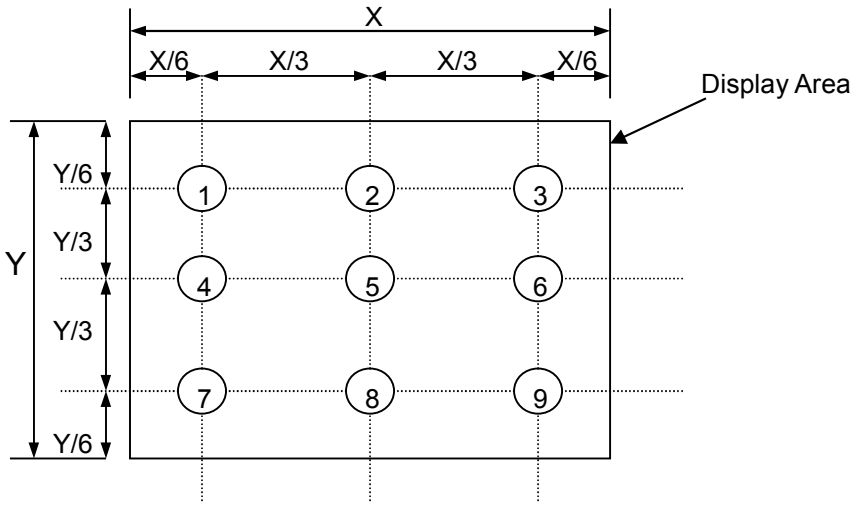
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

6.6.1. Surface Luminance: L_V = average (L_{P1}:L_{P9})

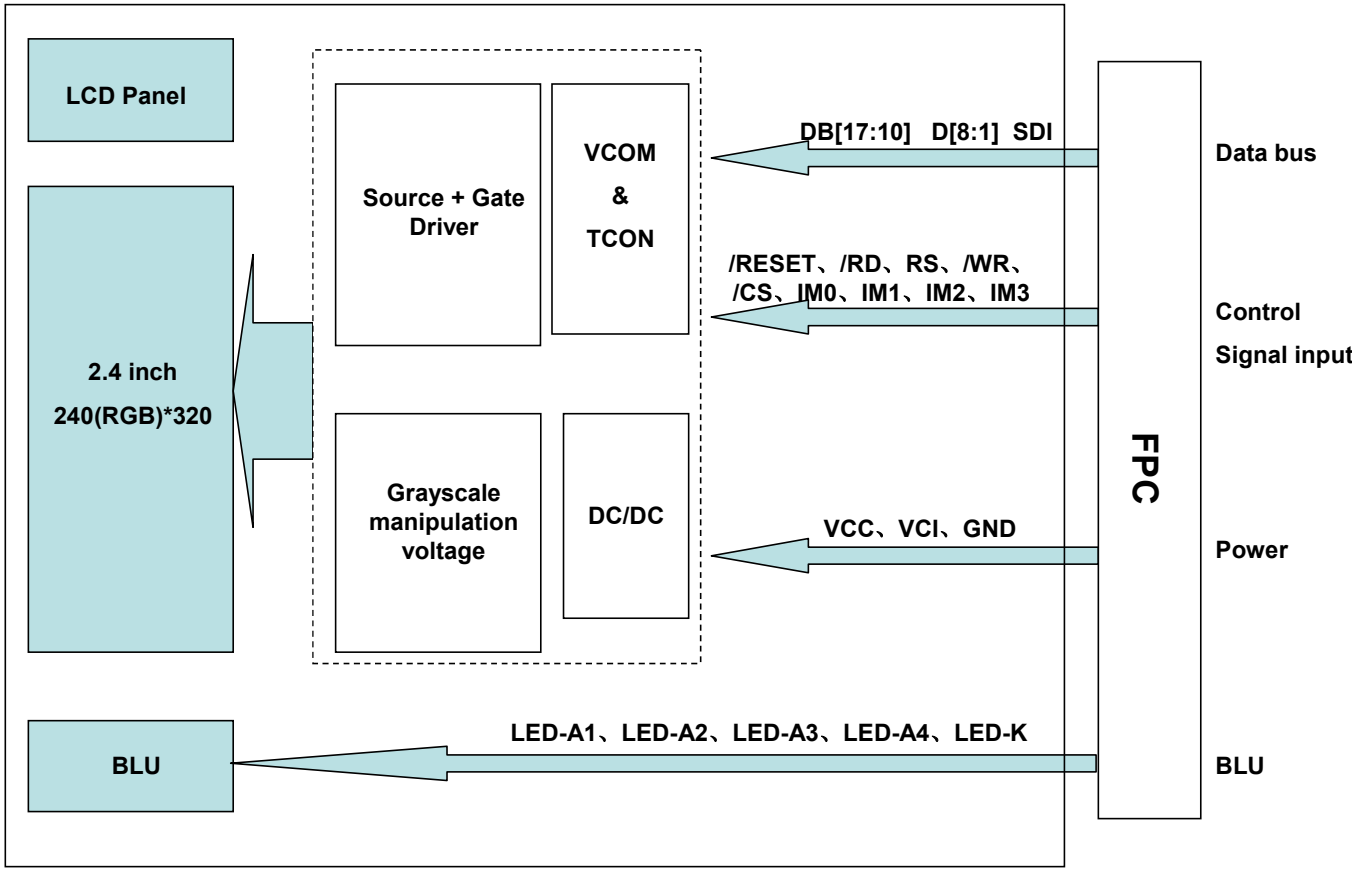
6.6.2. Uniformity = Minimal (L_{P1}:L_{P9}) / Maximal (L_{P1}:L_{P9}) * 100%

6.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



7. Block Diagram and Power Supply



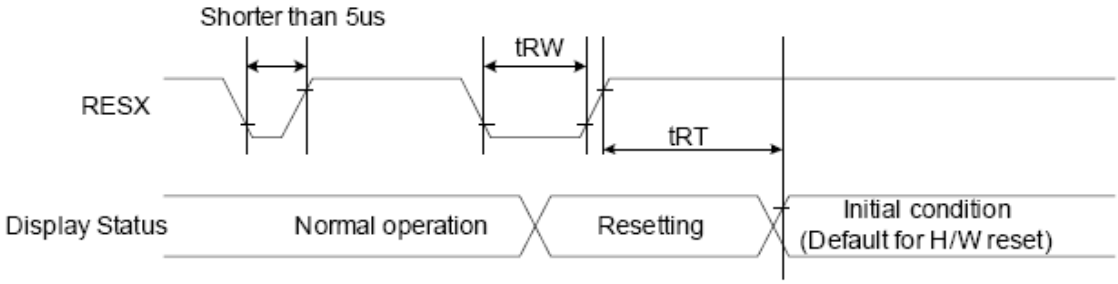
8. Interface Pins Definition

<table>
<tr><th>No.</th><th>Symbol</th><th>Function</th><th>Remark</th></tr>
<tr><td>1</td><td>DB10</td><td>Data bus.</td><td></td></tr>
<tr><td>2</td><td>DB11</td><td>Data bus.</td><td></td></tr>
<tr><td>3</td><td>DB12</td><td>Data bus.</td><td></td></tr>
<tr><td>4</td><td>DB13</td><td>Data bus.</td><td></td></tr>
<tr><td>5</td><td>GND</td><td>Ground.</td><td></td></tr>
<tr><td>6</td><td>VCC</td><td>Power supply: +2.8V.</td><td></td></tr>
<tr><td>7</td><td>/CS</td><td>L: Chip Selected; H: Chip Unselected.</td><td></td></tr>
<tr><td>8</td><td>RS</td><td>L: Command; H: Display data.</td><td></td></tr>
<tr><td>9</td><td>/WR</td><td>Write signal.</td><td></td></tr>
<tr><td>10</td><td>/RD</td><td>Read signal.</td><td></td></tr>
<tr><td>11
12
13</td><td>IM0
IM3
IM2</td><td>Select the MCU interface mode
<table>
<tr><th rowspan="2">IM3</th><th rowspan="2">IM2</th><th rowspan="2">IM1</th><th rowspan="2">IM0</th><th rowspan="2">MCU Interface Mode</th><th colspan="2">DB Pin in use</th></tr>
<tr><th>Register /Content</th><th>GRAM</th></tr>
<tr><td>1</td><td>0</td><td>0</td><td>0</td><td>80 MCU 16-bit bus Interface II</td><td>D[8:1]</td><td>D[17:10]
D[8:1]</td></tr>
<tr><td>1</td><td>0</td><td>0</td><td>1</td><td>80 MCU 8-bit bus Interface II</td><td>D[17:10]</td><td>D[17:10]</td></tr>
<tr><td>1</td><td>1</td><td>0</td><td>1</td><td>3-wire 9-bit data serial interface II</td><td colspan="2">SDI:In
SDO:OUT</td></tr>
<tr><td>1</td><td>1</td><td>1</td><td>0</td><td>4-wire 8-bit data serial interface II</td><td colspan="2">SDI:In
SDO:OUT</td></tr>
</table></td><td></td></tr>
<tr><td>14</td><td>SDI</td><td>SPI interface input pin.</td><td></td></tr>
<tr><td>15</td><td>SDO</td><td>SPI interface output pin.</td><td></td></tr>
<tr><td>16</td><td>NC(YU)</td><td>No connection.</td><td></td></tr>
<tr><td>17</td><td>NC(XL)</td><td>No connection.</td><td></td></tr>
<tr><td>18</td><td>NC(YD)</td><td>No connection.</td><td></td></tr>
<tr><td>19</td><td>NC(XR)</td><td>No connection.</td><td></td></tr>
<tr><td>20</td><td>LED-K</td><td>LED Cathode.</td><td></td></tr>
<tr><td>21</td><td>LED-A1</td><td>LED Anode.</td><td></td></tr>
<tr><td>22</td><td>LED-A2</td><td>LED Anode.</td><td></td></tr>
<tr><td>23</td><td>LED-A3</td><td>LED Anode.</td><td></td></tr>
<tr><td>24</td><td>LED-A4</td><td>LED Anode.</td><td></td></tr>
<tr><td>25</td><td>DB14</td><td>Data bus.</td><td></td></tr>
<tr><td>26</td><td>DB1</td><td>Data bus.</td><td></td></tr>
<tr><td>27</td><td>DB2</td><td>Data bus.</td><td></td></tr>
<tr><td>28</td><td>DB3</td><td>Data bus.</td><td></td></tr>
<tr><td>29</td><td>DB4</td><td>Data bus.</td><td></td></tr>
<tr><td>30</td><td>DB5</td><td>Data bus.</td><td></td></tr>
<tr><td>31</td><td>DB6</td><td>Data bus.</td><td></td></tr>
</table>

32	DB7	Data bus.	
33	DB8	Data bus.	
34	/RESET	L: Initialization is executed.	
35	VCI	A Power supply for step-up circuit and power supply circuit.	
36	VCC	Power supply: +2.8V.	
37	IM1	Select the MCU interface mode with IM0, IM3, IM2.	
38	DB15	Data bus.	
39	DB16	Data bus.	
40	DB17	Data bus.	

9. AC Characteristics

9.1. Reset timing



Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
	tRT	Reset cancel		5 (note 1,5)	mS
				120 (note 1,6,7)	mS

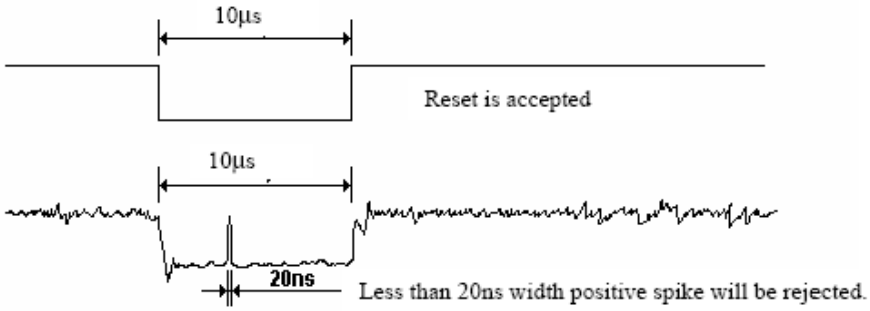
Note 1: The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.

Note 2: Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

Note 3: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In -mode.) And then return to Default condition for Hardware Reset.

Note 4: Spike Rejection also applies during a valid reset pulse as shown below:

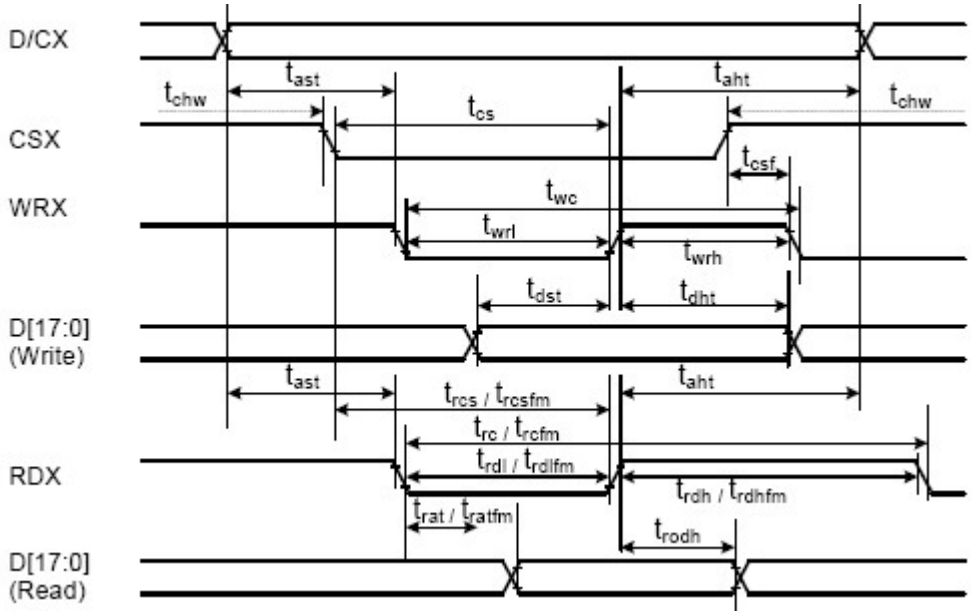


Note 5: When Reset applied during Sleep In Mode.

Note 6: When Reset applied during Sleep Out Mode.

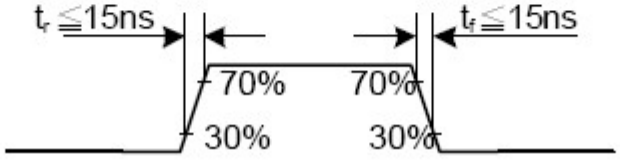
Note 7: It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

9.2. Display Parallel 16/8-bit Interface Timing Characteristics (8080-II system)

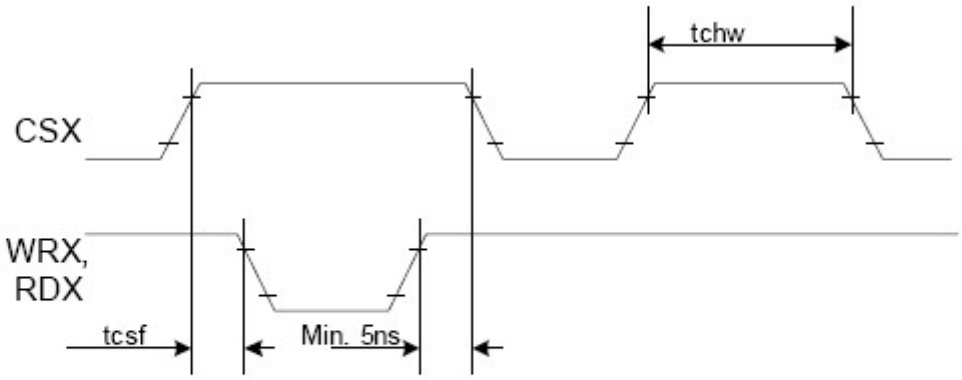


Signal	Symbol	Parameter	min	max	Unit	Description
DCX	tast	Address setup time	0	-	ns	
	taht	Address hold time (Write/Read)	0	-	ns	
CSX	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
WRX	twc	Write cycle	66	-	ns	
	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
RDX (FM)	trcfm	Read Cycle (FM)	450	-	ns	
	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
RDX (ID)	trc	Read cycle (ID)	160	-	ns	
	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D[17:0], D[17:10]&D[8:1], D[17:10], D[17:9]	tdst	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

Note: Ta = -30 to 70 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, VSS=0V.

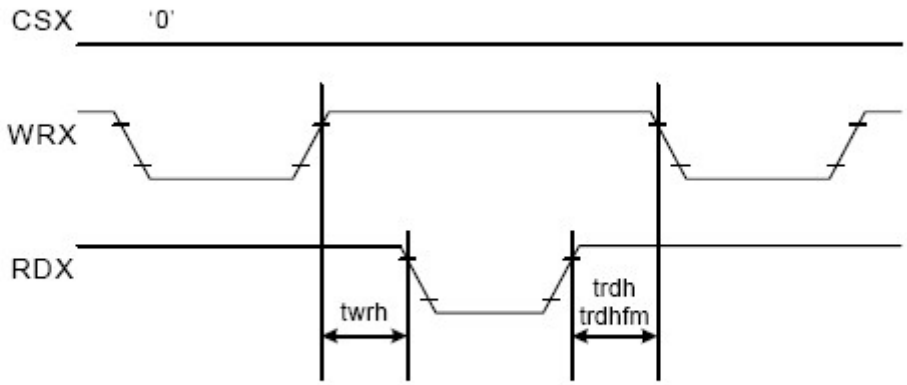


CSX timings :



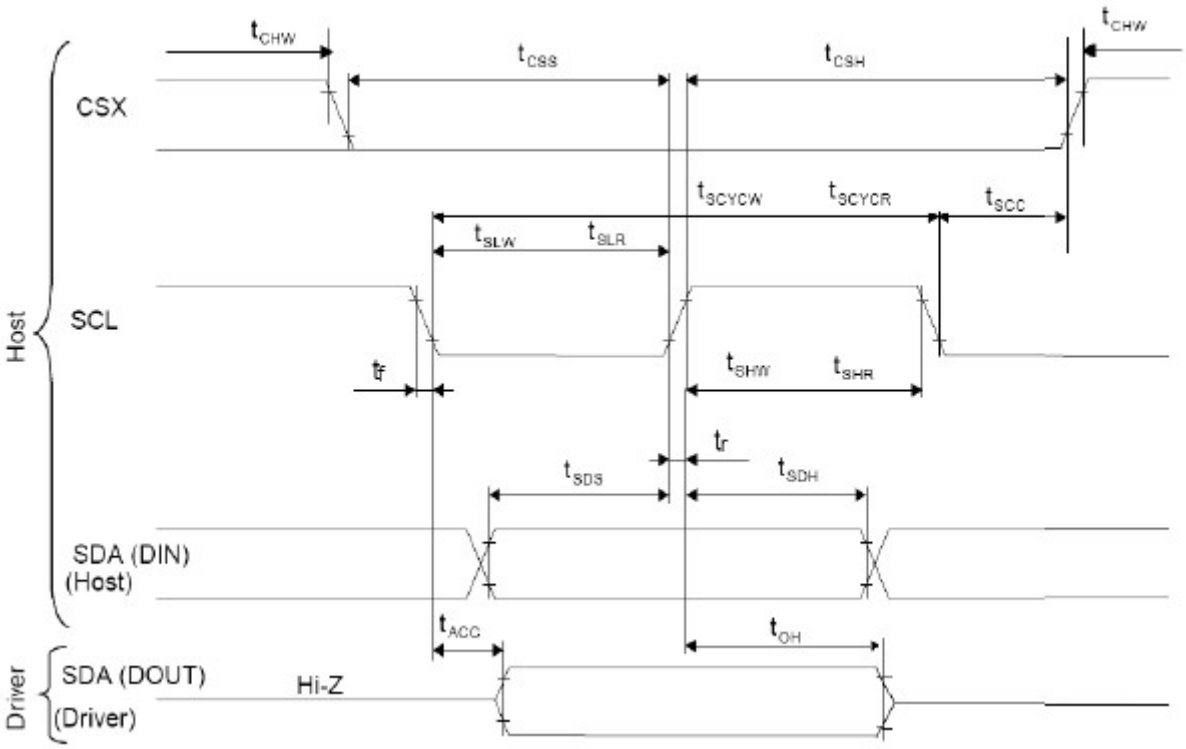
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:



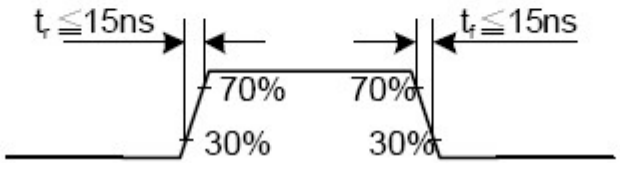
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

9.3. Display Serial Interface Timing Characteristics (3-line SPI system)

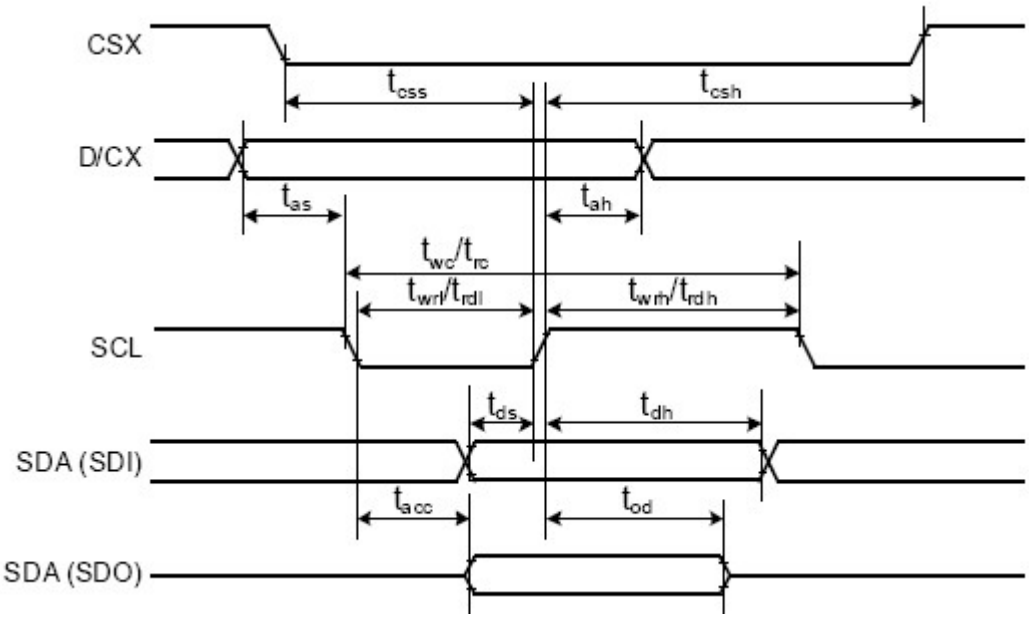


Signal	Symbol	Parameter	min	max	Unit	Description
SCL	tscycw	Serial Clock Cycle (Write)	100	-	ns	
	tshw	SCL "H" Pulse Width (Write)	40	-	ns	
	tslw	SCL "L" Pulse Width (Write)	40	-	ns	
	tscycr	Serial Clock Cycle (Read)	150	-	ns	
	tshr	SCL "H" Pulse Width (Read)	60	-	ns	
	tslr	SCL "L" Pulse Width (Read)	60	-	ns	
SDA / SDI (Input)	tsds	Data setup time (Write)	30	-	ns	
	tsdh	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	tacc	Access time (Read)	10	-	ns	
	toh	Output disable time (Read)	10	50	ns	
CSX	tscc	SCL-CSX	20	-	ns	
	tchw	CSX "H" Pulse Width	40	-	ns	
	tcss	CSX-SCL Time	60	-	ns	
	tcsh		65	-	ns	

Note: Ta = 25 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V

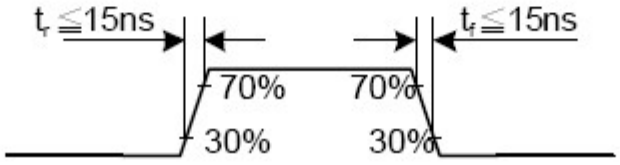


9.4. Display Serial Interface Timing Characteristics (4-line SPI system)



Signal	Symbol	Parameter	min	max	Unit	Description
CSX	tcss	Chip select time (Write)	40	-	ns	
	tcsh	Chip select hold time (Read)	40	-	ns	
SCL	twc	Serial clock cycle (Write)	100	-	ns	
	twrh	SCL "H" pulse width (Write)	40	-	ns	
	twrl	SCL "L" pulse width (Write)	40	-	ns	
	trc	Serial clock cycle (Read)	150	-	ns	
	trdh	SCL "H" pulse width (Read)	60	-	ns	
	trdl	SCL "L" pulse width (Read)	60	-	ns	
D/CX	tas	D/CX setup time	10	-		
	tah	D/CX hold time (Write / Read)	10	-		
SDA / SDI (Input)	tds	Data setup time (Write)	30	-	ns	
	tdh	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	tacc	Access time (Read)	10	-	ns	For maximum CL=30pF
	tod	Output disable time (Read)	10	50	ns	For minimum CL=8pF

Note: Ta = 25 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V



10. Command Table

Regulative Command Set													
Command Function	D/CX	RDX	WRX	D17-8	D7	D6	D5	D4	D3	D2	D1	D0	Hex
No Operation	0	1	↑	XX	0	0	0	0	0	0	0	0	00h
Software Reset	0	1	↑	XX	0	0	0	0	0	0	0	1	01h
Read Display Identification Information	0	1	↑	XX	0	0	0	0	0	1	0	0	04h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	ID1 [7:0]								XX
	1	↑	1	XX	ID2 [7:0]								XX
	1	↑	1	XX	ID3 [7:0]								XX
Read Display Status	0	1	↑	XX	0	0	0	0	1	0	0	1	09h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [31:25]							X	00
	1	↑	1	XX	X	D [22:20]			D [19:16]				61
	1	↑	1	XX	X	X	X	X	X	D [10:8]			00
	1	↑	1	XX	D [7:5]			X	X	X	X	X	00
Read Display Power Mode	0	1	↑	XX	0	0	0	0	1	0	1	0	0Ah
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [7:2]						0	0	08
Read Display MADCTL	0	1	↑	XX	0	0	0	0	1	0	1	1	0Bh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [7:2]						0	0	00
Read Display Pixel Format	0	1	↑	XX	0	0	0	0	1	1	0	0	0Ch
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	RIM	DPI [2:0]			X	DBI [2:0]			06
Read Display Image Format	0	1	↑	XX	0	0	0	0	1	1	0	1	0Dh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	X	X	X	X	X	D [2:0]			00
Read Display Signal Mode	0	1	↑	XX	0	0	0	0	1	1	1	0	0Eh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [7:2]						0	0	00
Read Display Self Diagnostic Result	0	1	↑	XX	0	0	0	0	1	1	1	1	0Fh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [7:6]		X	X	X	X	X	X	00
Enter Sleep Mode	0	1	↑	XX	0	0	0	1	0	0	0	0	10h
Sleep OUT	0	1	↑	XX	0	0	0	1	0	0	0	1	11h
Partial Mode ON	0	1	↑	XX	0	0	0	1	0	0	1	0	12h
Normal Display Mode ON	0	1	↑	XX	0	0	0	1	0	0	1	1	13h
Display Inversion OFF	0	1	↑	XX	0	0	1	0	0	0	0	0	20h
Display Inversion ON	0	1	↑	XX	0	0	1	0	0	0	0	1	21h
Gamma Set	0	1	↑	XX	0	0	1	0	0	1	1	0	26h
	1	1	↑	XX	GC [7:0]								01
Display OFF	0	1	↑	XX	0	0	1	0	1	0	0	0	28h
Display ON	0	1	↑	XX	0	0	1	0	1	0	0	1	29h
Column Address Set	0	1	↑	XX	0	0	1	0	1	0	1	0	2Ah
	1	1	↑	XX	SC [15:8]								XX
	1	1	↑	XX	SC [7:0]								XX
	1	1	↑	XX	EC [15:8]								XX
	1	1	↑	XX	EC [7:0]								XX
Page Address Set	0	1	↑	XX	0	0	1	0	1	0	1	1	2Bh
	1	1	↑	XX	SP [15:8]								XX
	1	1	↑	XX	SP [7:0]								XX
	1	1	↑	XX	EP [15:8]								XX
	1	1	↑	XX	EP [7:0]								XX

Memory Write	0	1	↑	XX	0	0	1	0	1	1	0	0	2Ch
	1	1	↑	D [17:0]									XX
Color SET	0	1	↑	XX	0	0	1	0	1	1	0	1	2Dh
	1	↑	1	XX			R00 [5:0]						XX
	1	↑	1	XX			Rnn [5:0]						XX
	1	↑	1	XX			R31 [5:0]						XX
	1	↑	1	XX			G00 [5:0]						XX
	1	↑	1	XX			Gnn [5:0]						XX
	1	↑	1	XX			G64 [5:0]						XX
	1	↑	1	XX			B00 [5:0]						XX
	1	↑	1	XX			Bnn [5:0]						XX
	1	↑	1	XX			B31 [5:0]						XX
Memory Read	0	1	↑	XX	0	0	1	0	1	1	1	0	2Eh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	D [17:0]									XX
Partial Area	0	1	↑	XX	0	0	1	1	0	0	0	0	30h
	1	1	↑	XX	SR [15:8]								00
	1	1	↑	XX	SR [7:0]								00
	1	1	↑	XX	ER [15:8]								01
	1	1	↑	XX	ER [7:0]								3F
Vertical Scrolling Definition	0	1	↑	XX	0	0	1	1	0	0	1	1	33h
	1	1	↑	XX	TFA [15:8]								00
	1	1	↑	XX	TFA [7:0]								00
	1	1	↑	XX	VSA [15:8]								01
	1	1	↑	XX	VSA [7:0]								40
	1	1	↑	XX	BFA [15:8]								00
	1	1	↑	XX	BFA [7:0]								00
Tearing Effect Line OFF	0	1	↑	XX	0	0	1	1	0	1	0	0	34h
Tearing Effect Line ON	0	1	↑	XX	0	0	1	1	0	1	0	1	35h
	1	1	↑	XX	X	X	X	X	X	X	X	M	00
Memory Access Control	0	1	↑	XX	0	0	1	1	0	1	1	0	36h
	1	1	↑	XX	MY	MX	MV	ML	BGR	MH	X	X	00
Vertical Scrolling Start Address	0	1	↑	XX	0	0	1	1	0	1	1	1	37h
	1	1	↑	XX	VSP [15:8]								00
	1	1	↑	XX	VSP [7:0]								00
Idle Mode OFF	0	1	↑	XX	0	0	1	1	1	0	0	0	38h
Idle Mode ON	0	1	↑	XX	0	0	1	1	1	0	0	1	39h
Pixel Format Set	0	1	↑	XX	0	0	1	1	1	0	1	0	3Ah
	1	1	↑	XX	X	DPI [2:0]			X	DBI [2:0]			66
Write Memory Continue	0	1	↑	XX	0	0	1	1	1	1	0	0	3Ch
	1	1	↑	D [17:0]									XX
Read Memory Continue	0	1	↑	XX	0	0	1	1	1	1	1	0	3Eh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	D [17:0]									XX
Set Tear Scanline	0	1	↑	XX	0	1	0	0	0	1	0	0	44h
	1	1	↑	XX	X	X	X	X	X	X	X	STS [8]	00
	1	1	↑	XX	STS [7:0]								00
Get Scanline	0	1	↑	XX	0	1	0	0	0	1	0	1	45h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	X	X	X	X	X	X	GTS [9:8]		00
	1	↑	1	XX	GTS [7:0]								00
Write Display Brightness	0	1	↑	XX	0	1	0	1	0	0	0	1	51h
	1	1	↑	XX	DBV [7:0]								00

Read Display Brightness	0	1	↑	XX	0	1	0	1	0	0	1	0	52h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	DBV [7:0]								00
Write CTRL Display	0	1	↑	XX	0	1	0	1	0	0	1	1	53h
	1	1	↑	XX	X	X	BCTRL	X	DD	BL	X	X	00
Read CTRL Display	0	1	↑	XX	0	1	0	1	0	1	0	0	54h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	X	X	BCTRL	X	DD	BL	X	X	00
Write Content Adaptive Brightness Control	0	1	↑	XX	0	1	0	1	0	1	0	1	55h
	1	1	↑	XX	X	X	X	X	X	X	C [1:0]		00
Read Content Adaptive Brightness Control	0	1	↑	XX	0	1	0	1	0	1	1	0	56h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	X	X	X	X	X	X	C [1:0]		00
Write CABC Minimum Brightness	0	1	↑	XX	0	1	0	1	1	1	1	0	5Eh
	1	1	↑	XX	CMB [7:0]								00
Read CABC Minimum Brightness	0	1	↑	XX	0	1	0	1	0	1	1	1	5Fh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	CMB [7:0]								00
Read ID1	0	1	↑	XX	1	1	0	1	1	0	1	0	DAh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	Module's Manufacture [7:0]								XX
Read ID2	0	1	↑	XX	1	1	0	1	1	0	1	1	DBh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	LCD Module / Driver Version [7:0]								XX
Read ID3	0	1	↑	XX	1	1	0	1	1	1	0	0	DCh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	LCD Module / Driver ID [7:0]								XX

Extended Command Set													
Command Function	D/CX	RDX	WRX	D17-8	D7	D6	D5	D4	D3	D2	D1	D0	Hex
RGB Interface Signal Control	0	1	↑	XX	1	0	1	1	0	0	0	0	B0h
	1	1	↑	XX	BYPASS MODE	RCM [1:0]		X	VSPL	HSPL	DPL	EPL	40
Frame Control (In Normal Mode)	0	1	↑	XX	1	0	1	1	0	0	0	1	B1h
	1	1	↑	XX	X	X	X	X	X	X	DIVA [1:0]		00
	1	1	↑	XX	X	X	X	RTNA [4:0]					1B
Frame Control (In Idle Mode)	0	1	↑	XX	1	0	1	1	0	0	1	0	B2h
	1	1	↑	XX	X	X	X	X	X	X	DIVB [1:0]		00
	1	1	↑	XX	X	X	X	RTNB [4:0]					1B
Frame Control (In Partial Mode)	0	1	↑	XX	1	0	1	1	0	0	1	1	B3h
	1	1	↑	XX	X	X	X	X	X	X	DIVC [1:0]		00
	1	1	↑	XX	X	X	X	RTNC [4:0]					1B
Display Inversion Control	0	1	↑	XX	1	0	1	1	0	1	0	0	B4h
	1	1	↑	XX	X	X	X	X	X	NLA	NLB	NLC	02
Blanking Porch Control	0	1	↑	XX	1	0	1	1	0	1	0	1	B5h
	1	1	↑	XX	0	VFP [6:0]							02
	1	1	↑	XX	0	VBP [6:0]							02
	1	1	↑	XX	0	0	0	HFP [4:0]					0A
	1	1	↑	XX	0	0	0	HBP [4:0]					14

Display Function Control	0	1	↑	XX	1	0	1	1	0	1	1	0	B6h
	1	1	↑	XX	X	X	X	X	PTG [1:0]		PT [1:0]		0A
	1	1	↑	XX	REV	GS	SS	SM	ISC [3:0]				82
	1	1	↑	XX	X	X	NL [5:0]						27
	1	1	↑	XX	X	X	PCDIV [5:0]						XX
Entry Mode Set	0	1	↑	XX	1	0	1	1	0	1	1	1	B7h
	1	1	↑	XX	X	X	X	X	DSTB	CON	DTE	GAS	07
Backlight Control 1	0	1	↑	XX	1	0	1	1	1	0	0	0	B8h
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX
	1	1	↑	XX	X	X	X	X	DTT_UI [3:0]				01
Backlight Control 2	0	1	↑	XX	1	0	1	1	1	0	0	1	B9h
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX
	1	1	↑	XX	TH_MV [3:0]				TH_ST [3:0]				B8
Backlight Control 3	0	1	↑	XX	1	0	1	1	1	0	1	0	BAh
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX
	1	1	↑	XX	X	X	X	X	DTT_UI [3:0]				01
Backlight Control 4	0	1	↑	XX	1	0	1	1	1	0	1	1	BBh
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX
	1	1	↑	XX	DTH_MV [3:0]				DTH_ST [3:0]				C9
Backlight Control 5	0	1	↑	XX	1	0	1	1	1	1	0	0	BCh
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX
	1	1	↑	XX	DIM2 [3:0]				X	DIM1 [2:0]			44
Backlight Control 7	0	1	↑	XX	1	0	1	1	1	1	1	0	BFh
	1	1	↑	XX	PWM_DIV [7:0]								0F
Backlight Control 8	0	1	↑	XX	1	0	1	1	1	1	1	1	BFh
	1	1	↑	XX	X	X	X	X	X	LEDONR	LEDONPOL	LEDPWMOPL	00
Power Control 1	0	1	↑	XX	1	1	0	0	0	0	0	0	C0h
	1	1	↑	XX	X	X	VRH [5:0]						26
Power Control 2	0	1	↑	XX	1	1	0	0	0	0	0	1	C1h
	1	1	↑	XX	X	X	X	X	X	BT [2:0]			00
VCOM Control 1	0	1	↑	XX	1	1	0	0	0	1	0	1	C5h
	1	1	↑	XX	X	VMH [6:0]							31
	1	1	↑	XX	X	VML [6:0]							3C
VCOM Control 2	0	1	↑	XX	1	1	0	0	0	1	1	1	C7h
	1	1	↑	XX	nVM	VMF [6:0]							C0
NV Memory Write	0	1	↑	XX	1	1	0	1	0	0	0	0	D0h
	1	1	↑	XX	X	X	X	X	X	PGM_ADR [2:0]			00
	1	1	↑	XX	PGM_DATA [7:0]								XX
NV Memory Protection Key	0	1	↑	XX	1	1	0	1	0	0	0	1	D1h
	1	1	↑	XX	KEY [23:16]								55
	1	1	↑	XX	KEY [15:8]								AA
	1	1	↑	XX	KEY [7:0]								66
NV Memory Status Read	0	1	↑	XX	1	1	0	1	0	0	1	0	D2h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	X	ID2_CNT [2:0]			X	ID1_CNT [2:0]			XX
	1	↑	1	XX	BUSY	VMF_CNT [2:0]			X	ID3_CNT [2:0]			XX

Read IDM	0	↑	1	XX	1	1	0	1	0	0	1	1	D3h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	0	0	0	0	0	0	0	0	00
	1	↑	1	XX	1	0	0	1	0	0	1	1	93
	1	↑	1	XX	0	1	0	0	0	0	0	1	41
Positive Gamma Correction	0	1	↑	XX	1	1	1	0	0	0	0	0	E0h
	1	1	↑	XX	X	X	X	X	VP0 [3:0]				08
	1	1	↑	XX	X	X	VP1 [5:0]						0F
	1	1	↑	XX	X	X	VP2 [5:0]						12
	1	1	↑	XX	X	X	X	X	VP4 [3:0]				05
	1	1	↑	XX	X	X	X	VP6 [4:0]					03
	1	1	↑	XX	X	X	X	X	VP13 [3:0]				09
	1	1	↑	XX	X	VP20 [6:0]							47
	1	1	↑	XX	VP36 [3:0]				VP27 [3:0]				80
	1	1	↑	XX	X	VP43 [6:0]							2B
	1	1	↑	XX	X	X	X	X	VP50 [3:0]				0B
	1	1	↑	XX	X	X	X	VP57 [4:0]					01
	1	1	↑	XX	X	X	X	X	VP59 [3:0]				00
	1	1	↑	XX	X	X	VP61 [5:0]						00
	1	1	↑	XX	X	X	VP62 [5:0]						00
	1	1	↑	XX	X	X	X	X	VP63 [3:0]				00
Negative Gamma Correction	0	1	↑	XX	1	1	1	0	0	0	0	1	E1h
	1	1	↑	XX	X	X	X	X	VN0 [3:0]				00
	1	1	↑	XX	X	X	VN1 [5:0]						1A
	1	1	↑	XX	X	X	VN2 [5:0]						20
	1	1	↑	XX	X	X	X	X	VN4 [3:0]				07
	1	1	↑	XX	X	X	X	VN6 [4:0]					0F
	1	1	↑	XX	X	X	X	X	VN13 [3:0]				05
	1	1	↑	XX	X	VN20 [6:0]							3A
	1	1	↑	XX	VN36 [3:0]				VN27 [3:0]				9A
	1	1	↑	XX	X	VN43 [6:0]							40
	1	1	↑	XX	X	X	X	X	VN50 [3:0]				04
	1	1	↑	XX	X	X	X	VN57 [4:0]					18
	1	1	↑	XX	X	X	X	X	VN59 [3:0]				0F
	1	1	↑	XX	X	X	VN61 [5:0]						3F
	1	1	↑	XX	X	X	VN62 [5:0]						3F
	1	1	↑	XX	X	X	X	X	VN63 [3:0]				0F
Digital Gamma Control 1	0	1	↑	XX	1	1	1	0	0	0	1	0	F2h
1st Parameter	1	1	↑	XX	RCA0 [3:0]				RGA0 [3:0]				XX
.	1	1	↑	XX	RCAx [3:0]				BGAx [3:0]				XX
16th Parameter	1	1	↑	XX	RCA15 [3:0]				BGA15 [3:0]				XX
Digital Gamma Control 2	0	1	↑	XX	1	1	1	0	0	0	1	1	F3h
1st Parameter	1	1	↑	XX	RFA0 [3:0]				BFA0 [3:0]				XX
.	1	1	↑	XX	RFAx [3:0]				BFAx [3:0]				XX
64th Parameter	1	1	↑	XX	RFA63 [3:0]				BFA63 [3:0]				XX
Interface Control	0	1	↑	XX	1	1	1	1	0	1	1	0	F6h
	1	1	↑	XX	MY_EOR	MX_EOR	MV_EOR	X	BGR_EOR	X	X	WEMODE	01
	1	1	↑	XX	X	X	LPF [1:0]		X	X	MDT [1:0]		00
	1	1	↑	XX	X	X	EPF[1:0]	X	DM [1:0]		RM	RIM	00

Note 1: Undefined commands are treated as NOP (00h) command.

Note 2: B0 to D9 and DE to FF are for factory use of display supplier. USER can decide if these commands are available or they are treated as NOP (00h) commands before shipping to USER. Default value is NOP (00h).

Note 3: Commands 10h, 12h, 13h, 26h, 28h, 29h, 30h, 36h (Bit B4 only), 38h and 39h are updated during V-SYNC when ILI9340C is in Sleep OUT mode to avoid abnormal visual effects. During Sleep IN mode, these commands are updated immediately. Read status (09h), Read display power mode (0Ah), Read display MADCTL (0Bh), Read display pixel format (0Ch), Read display image mode (0Dh), Read display signal mode (0Eh) and Read display self diagnostic result (0Fh) of these commands are updated immediately both in Sleep IN mode and Sleep OUT mode.

11. Quality Assurance

11.1. Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

11.2. Standard for Quality Test

11.2.1 Sampling Plan:

ANSI / ASQC Z1.4-1993.

Single sampling, normal inspection.

11.2.2 Sampling Criteria:

Visual inspection: AQL 1.5%

Electrical functional: AQL 0.65%.

11.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

11.3. Nonconforming Analysis & Disposition

11.3.1 Nonconforming analysis:

11.3.1.1 Customer should provide overall information of non-conforming sample for their complaints.

11.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

11.3.1.3 If cannot finish the analysis on time, customer will be notified with the progress status.

11.3.2 Disposition of nonconforming:

11.3.2.1 Non-conforming product over PPM level will be replaced.

11.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

11.4. Agreement Items

Shall negotiate with customer if the following situation occurs:

11.4.1 There is any discrepancy in standard of quality assurance.

11.4.2 Additional requirement to be added in product specification.

11.4.3 Any other special problem.

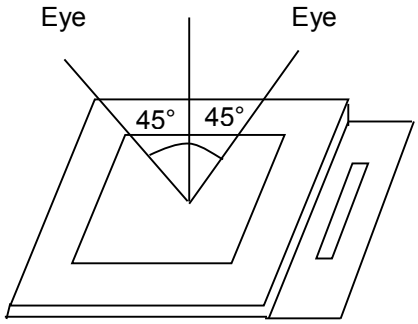
11.5. Standard of the Product Visual Inspection

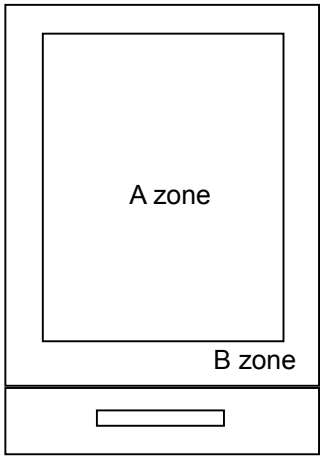
11.5.1 Appearance inspection:

11.5.1.1 The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

11.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

11.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,



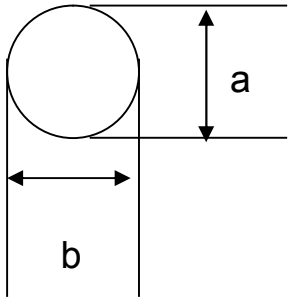


11.5.2 Basic principle:

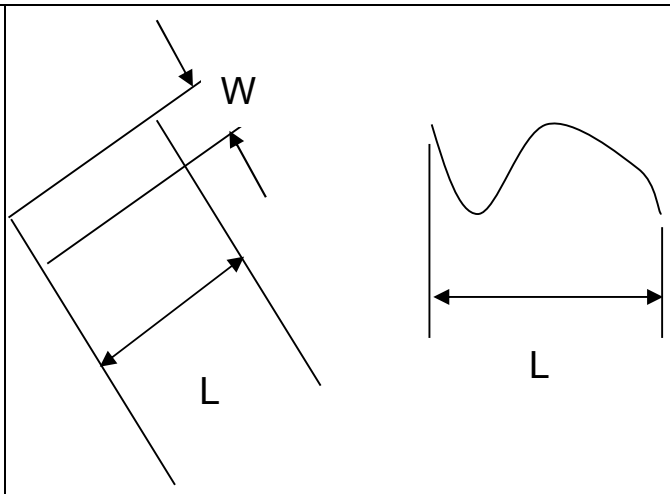
11.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

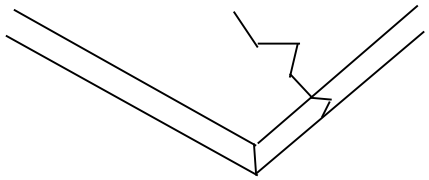
11.5.2.2 New item must be added on time when it is necessary.

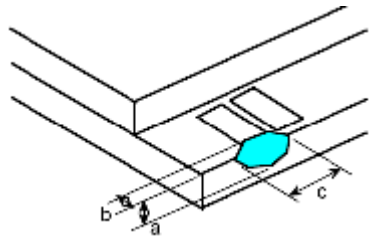
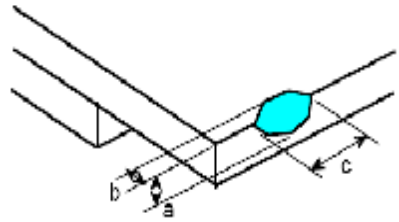
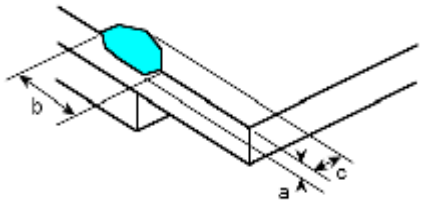
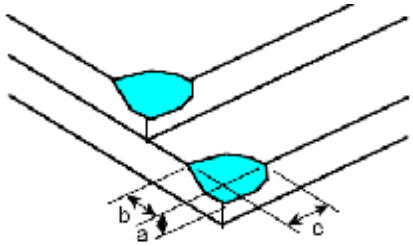
11.6.Inspection Specification

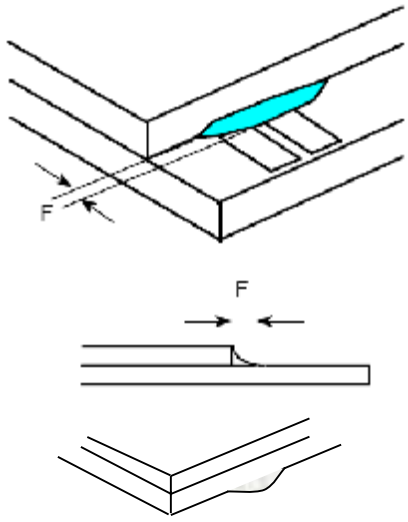
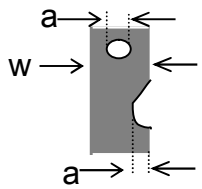
<table>
<tr><th>No.</th><th>Item</th><th>Criteria (Unit: mm)</th></tr>
<tr><td>01</td><td>Black / White spot
Foreign material
(Round type)
Pinholes
Stain
Particles inside cell.
(Minor defect)</td><td>


φ= (a + b) /2
<table>
<tr><th>Area / Size</th><th>Acc. Qty</th></tr>
<tr><td>φ≤0.10</td><td>Ignore</td></tr>
<tr><td>0.10<φ≤0.15</td><td>2</td></tr>
<tr><td>0.15<φ≤0.25</td><td>1</td></tr>
<tr><td>0.25<φ</td><td>0</td></tr>
<tr><td>Total</td><td>2 no include φ≤ 0.10</td></tr>
</table>
Distance between 2 defects should more than 3mm apart.
</td></tr>
</table>

<table>
<tr>
<td>02</td>
<td>Black and White line
Scratch
Foreign material
(Line type)
(Minor defect)</td>
<td>


<table>
<tr><th>Length</th><th>Width</th><th>Acc. Qty</th></tr>
<tr><td>/</td><td>W ≦ 0.03</td><td>Ignore</td></tr>
<tr><td>L ≦ 2.5</td><td>0.03 ＜ W ≦ 0.05</td><td>3</td></tr>
<tr><td>L ≦ 2.5</td><td>0.05 ＜ W ≦ 0.10</td><td>2</td></tr>
<tr><td>/</td><td>0.1 ＜ W</td><td>0</td></tr>
<tr><td colspan="2">Total</td><td>3</td></tr>
</table>
Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.
</td>
</tr>
<tr>
<td>03</td>
<td>Glass Crack
(Minor defect)</td>
<td>

Crack is potential to enlarge, any type is not allowed.
</td>
</tr>
</table>

<table>
<tr>
<td>04</td>
<td>Glass Chipping Pad Area:
(Minor defect)
 
</td>
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c > 3.0, b< 1.0</td><td>1</td></tr>
<tr><td>c< 3.0, b< 1.0</td><td>3</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
<tr>
<td>05</td>
<td>Glass Chipping Rear of Pad Area:
(Minor defect)
 
</td>
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c > 3.0, b< 1.0</td><td>1</td></tr>
<tr><td>c< 3.0, b< 1.0</td><td>2</td></tr>
<tr><td>c< 3.0, b< 0.5</td><td>4</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
<tr>
<td>06</td>
<td>Glass Chipping Except Pad Area:
(Minor defect)
 
</td>
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c > 3.0, b< 1.0</td><td>1</td></tr>
<tr><td>c< 3.0, b< 1.0</td><td>2</td></tr>
<tr><td>c< 3.0, b< 0.5</td><td>4</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
<tr>
<td>07</td>
<td>Glass Corner Chipping:
(Minor defect)
 
</td>
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c < 3.0, b< 3.0</td><td>Ignore</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
</table>

<table>
<tr>
<td>08</td>
<td>Glass Burr:
(Minor defect)
 
</td>
<td><table><tr><th>Length</th><th>Acc. Qty</th></tr><tr><td>F < 1.0</td><td>Ignore</td></tr></table>
Glass burr don’t affect assemble and module dimension.</td>
</tr>
<tr>
<td>09</td>
<td>FPC Defect:
(Minor defect)
 
</td>
<td>9.1 Dent, pinhole width a<w/3.
(w: circuitry width.)
9.2 Open circuit is unacceptable.
9.3 No oxidation, contamination and distortion.</td>
</tr>
<tr>
<td>10</td>
<td>Bubble on Polarizer
(Minor defect)</td>
<td><table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>φ≤0.20</td><td>Ignore</td></tr><tr><td>0.20 <φ≤0.30</td><td>4</td></tr><tr><td>0.30 < φ</td><td>None</td></tr></table></td>
</tr>
<tr>
<td>11</td>
<td>Dent on Polarizer
(Minor defect)</td>
<td><table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>φ≤0.20</td><td>Ignore</td></tr><tr><td>0.20 <φ≤0.30</td><td>4</td></tr><tr><td>0.30 < φ</td><td>None</td></tr></table></td>
</tr>
<tr>
<td>12</td>
<td>Bezel</td>
<td>12.1 No rust, distortion on the Bezel.
12.2 No visible fingerprints, stains or other contamination.</td>
</tr>
</table>

13	Touch Panel	D: Diameter W: width L: length 13.1 Spot: D<0.25 is acceptable 0.25≤D≤0.4 2dots are acceptable and the distance between defects should more than 10 mm. D>0.4 is unacceptable 13.2 Dent: D>0.40 is unacceptable 13.3 Scratch: W≤0.03, L≤10 is acceptable, 0.03<W≤0.10, L≤10 is acceptable Distance between 2 defects should more than 10 mm. W>0.10 is unacceptable.
14	PCB	14.1 No distortion or contamination on PCB terminals. 14.2 All components on PCB must same as documented on the BOM/component layout. 14.3 Follow IPC-A-600F.
15	Soldering	Follow IPC-A-610C standard
16	Electrical Defect (Major defect)	The below defects must be rejected. 16.1 Missing vertical / horizontal segment, 16.2 Abnormal Display. 16.3 No function or no display. 16.4 Current exceeds product specifications. 16.5 LCD viewing angle defect. 16.6 No Backlight. 16.7 Dark Backlight. 16.8 Touch Panel no function. 16.9 Dark Dot –one Allowed. 16.10 Bright Dot – one Allowed. Remark: 1. A pixel defect is acceptable if one color is none functional and causes a bright dot. The display may have one case where one color is out and cause a dark dot. 2. Bright dot caused by scratch and foreign object accords to item 1.

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

11.7. Classification of Defects

11.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.

11.7.2 Two minor defects are equal to one major in lot sampling inspection.

11.8. Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

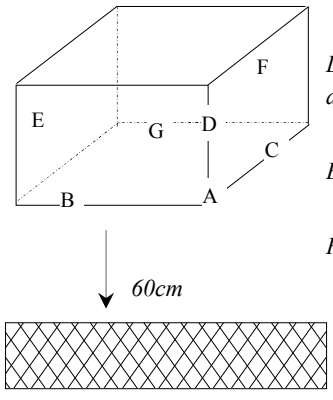
11.9. Packing

11.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.

11.9.2 Modules inside package box should have compliant mark.

11.9.3 All direct package materials shall offer ESD protection

12. Reliability Specification

No	Item	Condition	Quantity
1	High Temperature Operating	70℃, 96Hrs	5
2	Low Temperature Operating	-20℃,96Hrs	5
3	High Humidity	50℃, 90%RH, 96Hrs	5
4	High Temperature Storage	80℃, 96Hrs	5
5	Low Temperature Storage	-30℃, 96Hrs	5
6	Thermal shock	-20℃, 30min~70℃, 30min, 10 cycles.	5
7	Packing vibration	Frequency range:10Hz~55Hz Amplitude of vibration:1.5mm Sweep time:12min X,Y,Z 2 hours for each direction.	5
8	Electrical Static Discharge	Air:±4KV 150pF/330Ω 5 times	5
		Contact:±2KV 150pF/330Ω 5 times	
9	Drop Test	To be measured after dropping from 60cm high on the concrete surface in packing state.  *Dropping method corner dropping* *A corner: once* *Edge dropping* *B, C, D edge: once* *Face dropping* *E, F, G face: once*	5

Note1. No defection cosmetic and operational function allowable.

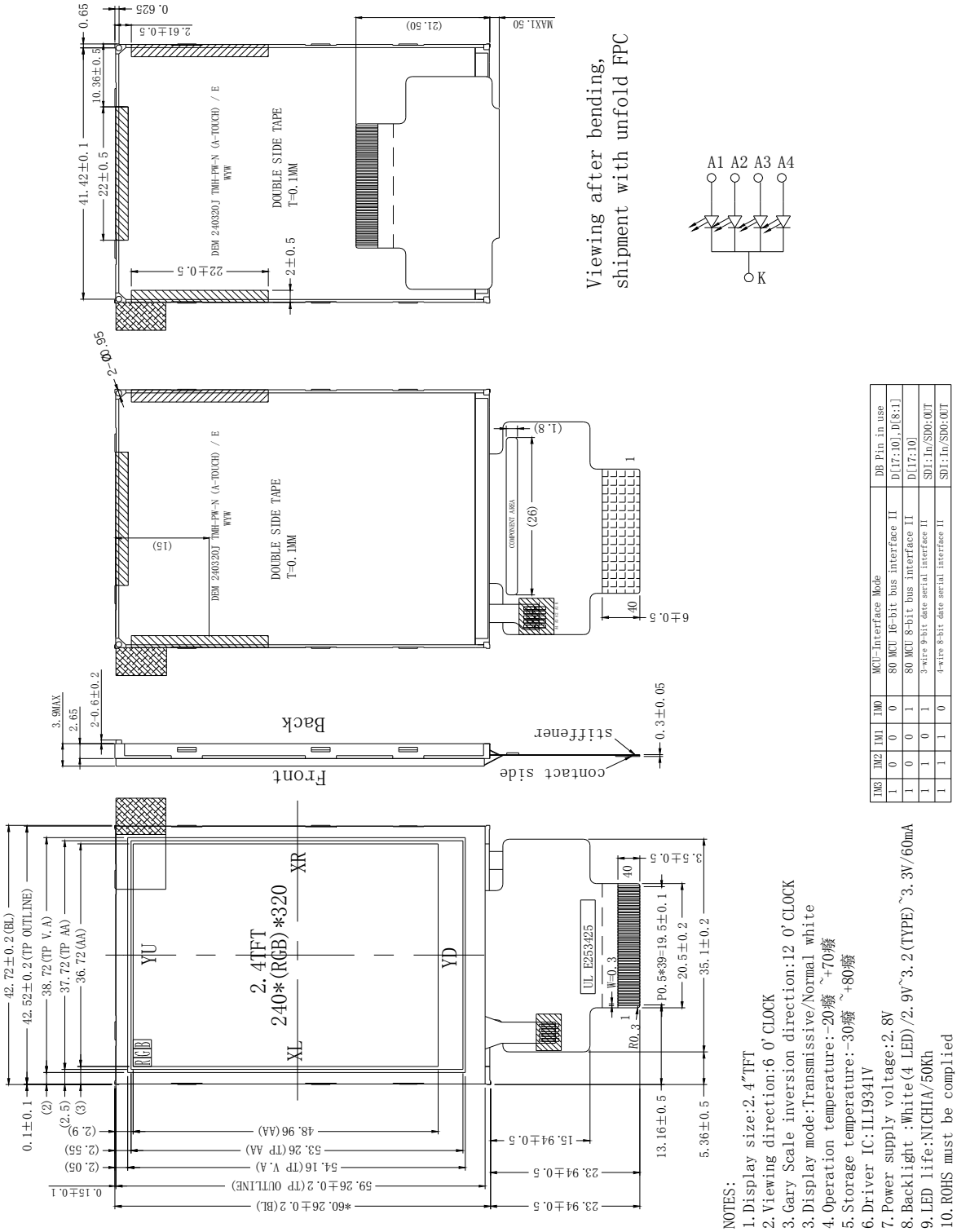
Note2. Total current Consumption should be below double of initial value

13. Packaging

t.b.d.

14. Outline Drawing

PIN	SYMBOL
1	DB10
2	DB11
3	DB12
4	DB13
5	GND
6	VCC
7	/CS
8	RS
9	/WR
10	/RD
11	IM0
12	IM3
13	IM2
14	SDI
15	SDO
16	YU
17	XL
18	YD
19	XR
20	LED-K
21	LED-A1
22	LED-A2
23	LED-A3
24	LED-A4
25	DB14
26	DB1
27	DB2
28	DB3
29	DB4
30	DB5
31	DB6
32	DB7
33	DB8
34	/RESET
35	VCI
36	VCC
37	IM1
38	DB15
39	DB16
40	DB17



IM3	IM2	IM1	IM0	MCU-Interface Mode	DB Pin in use
1	0	0	0	80 MCU 16-bit bus interface II	D[17:10],D[8:1]
1	0	0	1	80 MCU 8-bit bus interface II	D[17:10]
1	1	0	1	3-wire 9-bit date serial interface II	SDI:In/SDO:OUT
1	1	1	0	4-wire 8-bit date serial interface II	SDI:In/SDO:OUT

NOTES:
1. Display size:2.4"TFT
2. Viewing direction:6 O'CLOCK
3. Gary Scale inversion direction:12 O'CLOCK
3. Display mode:Transmissive/Normal white
4. Operation temperature:-20℃ ~+70℃
5. Storage temperature:-30℃ ~+80℃
6. Driver IC:ILI9341V
7. Power supply voltage:2.8V
8. Backlight :White(4 LED)/2.9V~3.2(TYPE)~3.3V/60mA
9. LED life:NICHIA/50Kh
10. ROHS must be complied
* Unspecification tolerance are ? .2mm